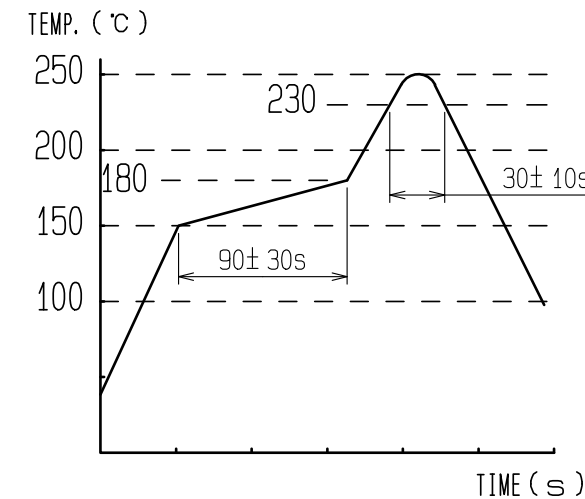


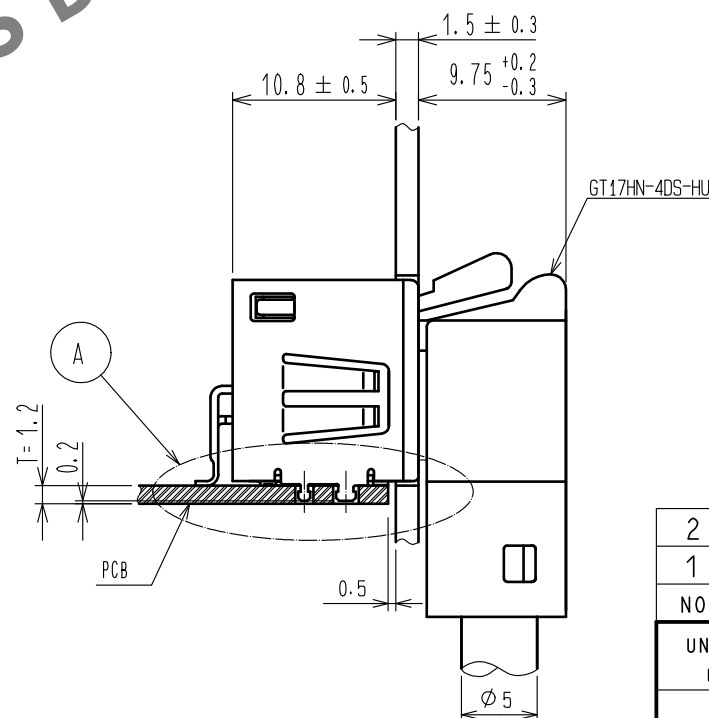
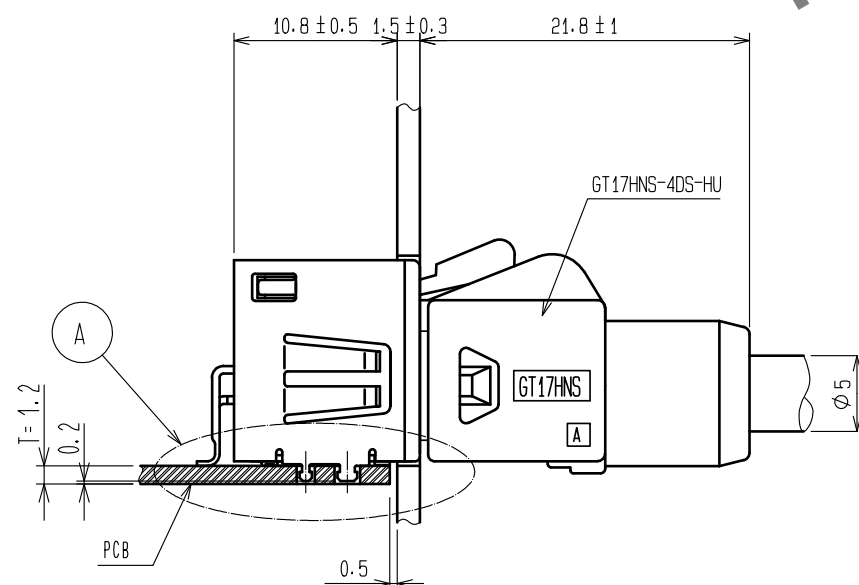
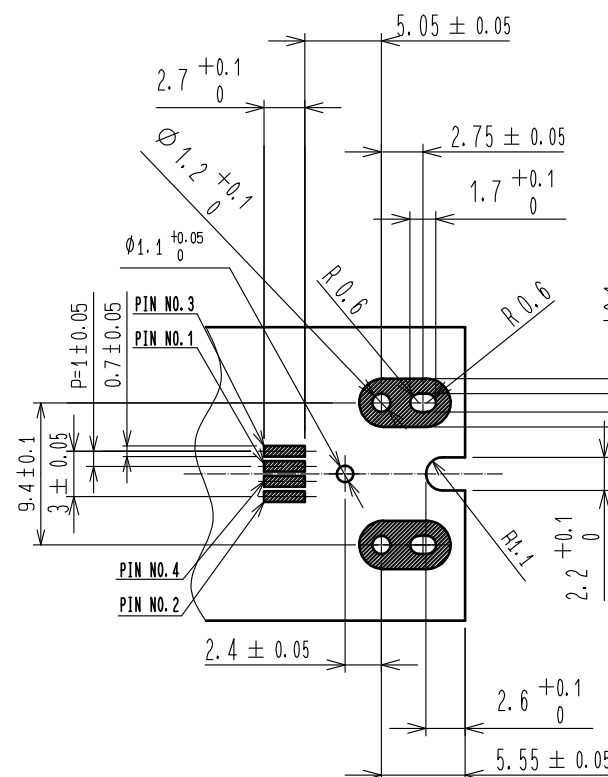
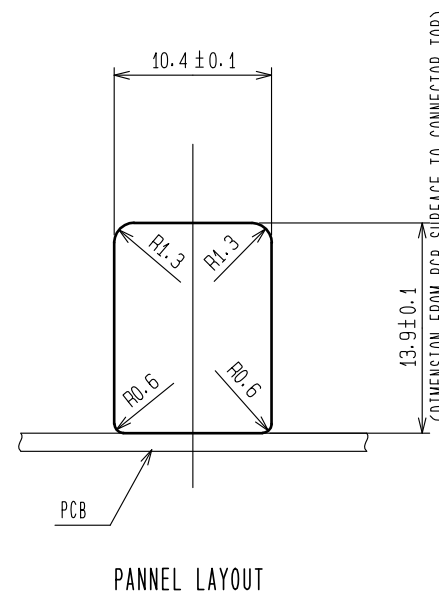
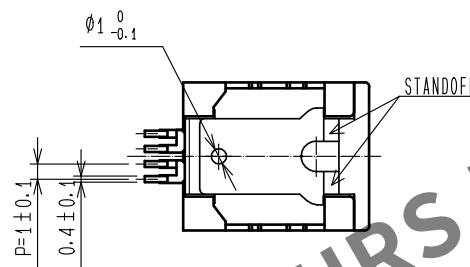
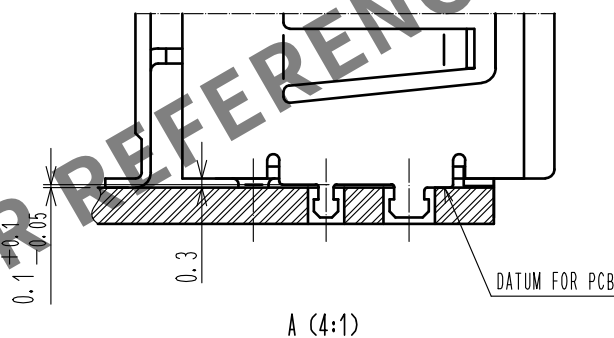
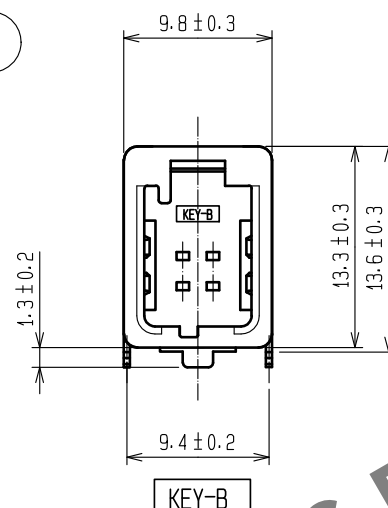
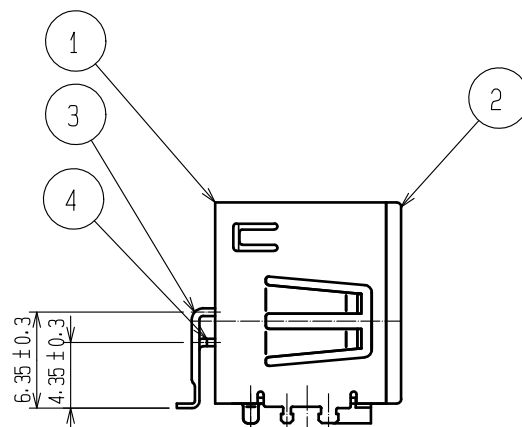
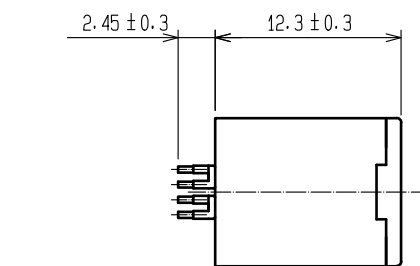
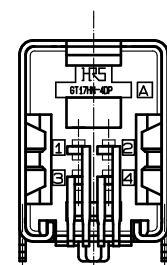
ELV, RoHS COMPLIANT

NOTES

- 1) RECOMMENDED REFLOW PROFILE (SEE RIGHT GRAPH)
CYCLE TIME: UP TO 2 CYCLES OF REFLOW SOLDERING ARE POSSIBLE UNDER THE CONDITIONS, PROVIDED THAT THERE IS A RETURN TO NOMAL TEMPERATURE BETWEEN THE FIRST AND SECOND CYCLE.
PEAK TEMPERATURE: 250°C
230°C MIN. FOR 20 TO 40 SECONDS.
PREHEATING AREA 150 TO 180 °C FOR 60 TO 120 SECONDS.
- 2) HAND SOLDERING: 280-300°C, 2S MAX.
- 3) CONTACT COPLANARITY: 0.1mm MAX.
- 4) RECOMMENDED THICKNESS OF PCB: 1.2mm
- 5) RECOMMENDED THICKNESS OF SOLDERING PASTE: 0.12mm



HRS DRAWING FOR REFERENCE



2	PPS	GREEN	4	BRASS	TIN PLATING
1	COPPER ALLOY	TIN PLATING	3	BRASS	TIN PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED
HIROSE ELECTRIC CO., LTD.		APPROVED : KI. HIROKAWA	20200331	DRAWING NO.	EDC-167010-58-00
		CHECKED : EJ. WAKATSUKI	20200330	PART NO.	GT17HN-4DP-2H(B)(58)
		DESIGNED : TS. KUBOTA	20200325	CODE NO.	CL767-0175-0-58
		DRAWN : YK. MITSUISHI	20200313		

HRS

DRAWING NO.	EDC-167010-58-00	
PART NO.	GT17HN-4DP-2H(B)(58)	
CODE NO.	CL767-0175-0-58	

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